



## GaAs pHEMT MMIC 2 WATT POWER AMPLIFIER, 27.5 - 31 GHz

### Typical Applications

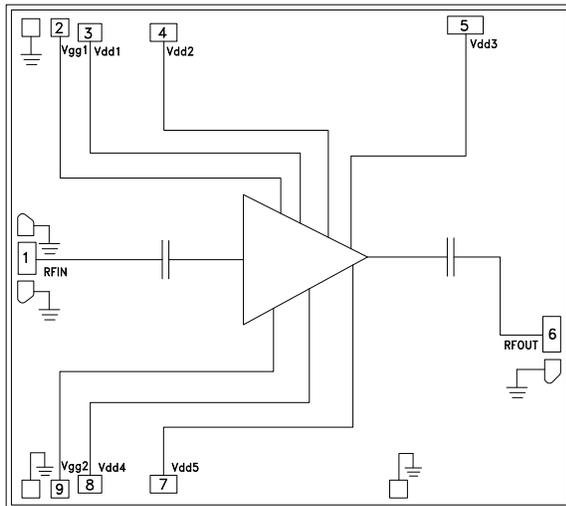
The HMC7441 is ideal for:

- Point-to-Point Radios
- Point-to-Multi-Point Radios
- VSAT & SATCOM
- Military & Space

### Features

- Saturated Output Power: +34 dBm @ 25% PAE
- High Output IP3: +38 dBm
- High Gain: 23 dB
- DC Supply: +6V @ 1000 mA
- No External Matching Required
- Die Size: 3.18 x 2.84 x 0.1 mm

### Functional Diagram



### General Description

The HMC7441 is a three-stage GaAs pHEMT Power Amplifier which operates between 27.5 and 31 GHz. The amplifier provides 23 dB of gain and +34 dBm of saturated output power at 25% PAE from a 6V supply. With an excellent output IP3 of +38 dBm, the HMC7441 is ideal for linear application such as Ka-band VSAT or high capacity point-to-point or point-to-multi-point radios demanding +34 dBm of efficient saturated output power. The RF I/Os are DC blocked and matched to 50 Ohms for ease of integration into Multi-Chip-Modules (MCMs). All data is taken with the chip in a 50 Ohm test fixture connected via (1) 0.025mm (1 mil) diameter wire bonds of 0.31 mm (12 mil) length.

### Electrical Specifications, $T_A = +25^\circ C$

$V_{dd} = V_{dd1}, V_{dd2}, V_{dd3}, V_{dd4}, V_{dd5} = +6V, I_{dd} = 1000 mA$  [1]

Parameter	Min.	Typ.	Max.	Units
Frequency Range		27.5 - 31		GHz
Gain	20	23		dB
Gain Variation Over Temperature		0.03		dB/°C
Input Return Loss		8		dB
Output Return Loss		8		dB
Output Power for 1 dB Compression (P1dB)	31	34		dBm
Saturated Output Power (Psat)		34		dBm
Output Third Order Intercept (IP3) <sup>[2]</sup>		38		dBm
Total Supply Current (Idd)		1000		mA

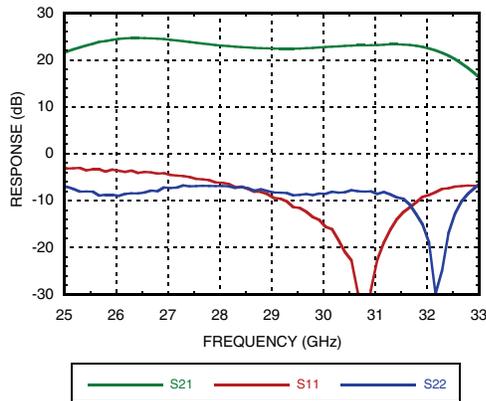
[1] Adjust Vgg between -2 to 0V to achieve Idd = 1000 mA typical.

[2] Measurement taken at +6V @ 1000 mA, Pout / Tone = +28 dBm

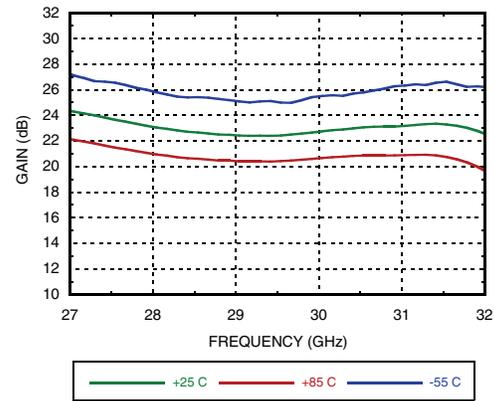


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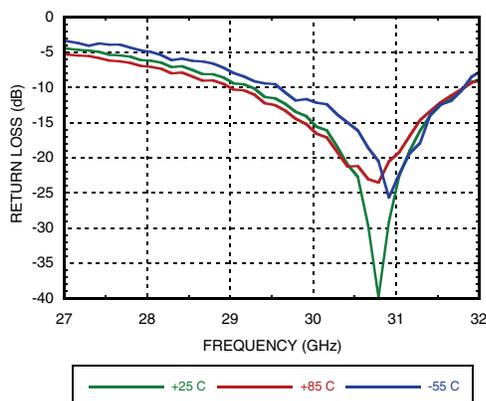
**Broadband Gain & Return Loss vs. Frequency**



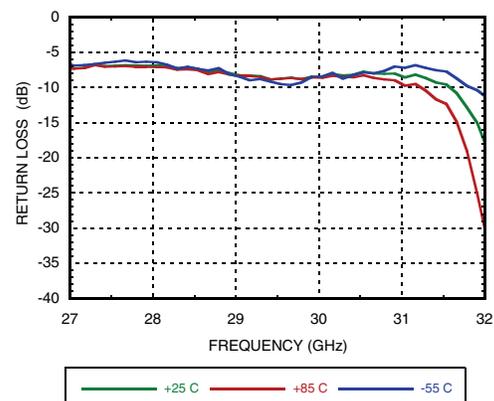
**Gain vs. Temperature**



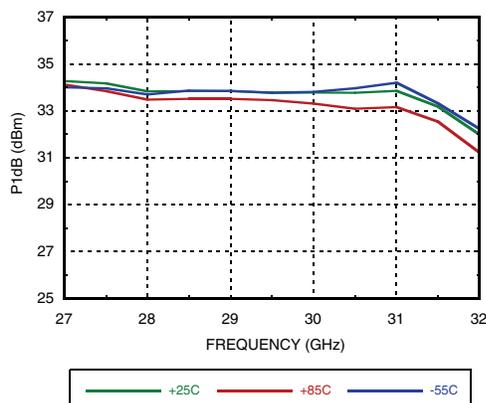
**Input Return Loss vs. Temperature**



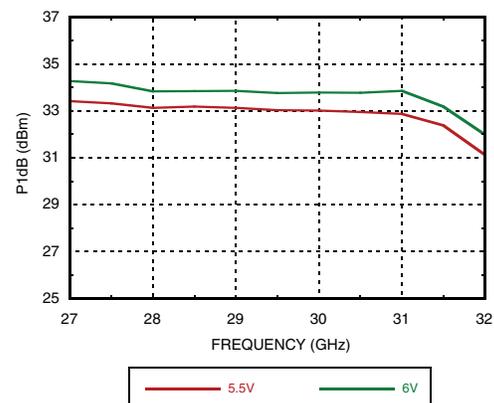
**Output Return Loss vs. Temperature**



**P1dB vs. Temperature**



**P1dB vs. Supply Voltage**



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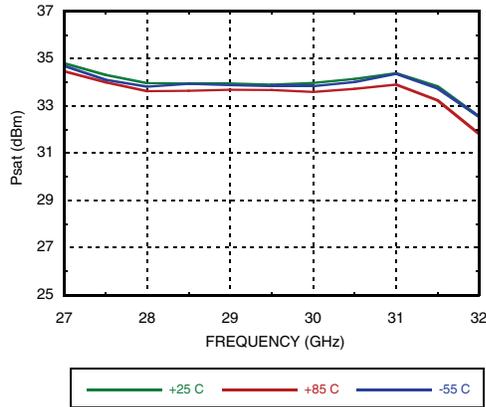
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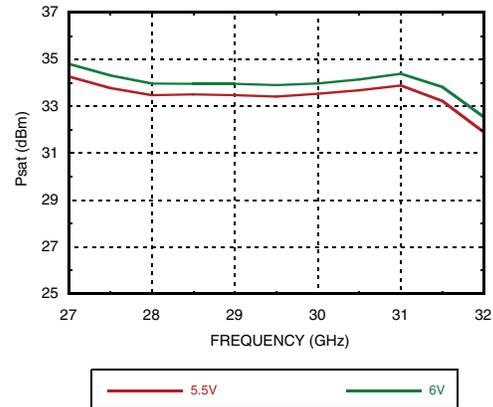
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AMPLIFIERS - LINEAR & POWER - CHIP

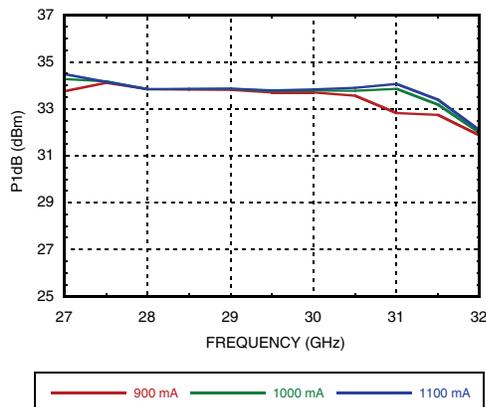
**Psat vs. Temperature**



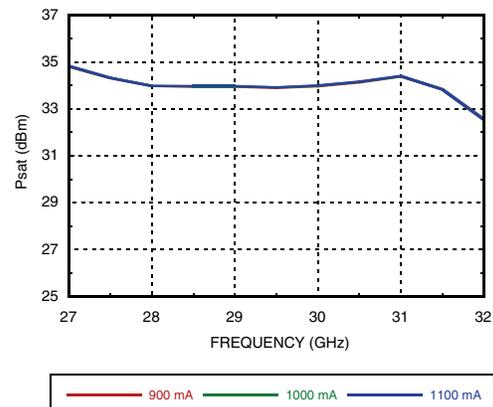
**Psat vs. Supply Voltage**



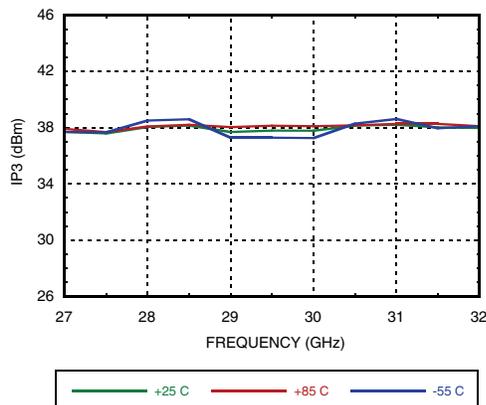
**P1dB vs. Supply Current (Idd)**



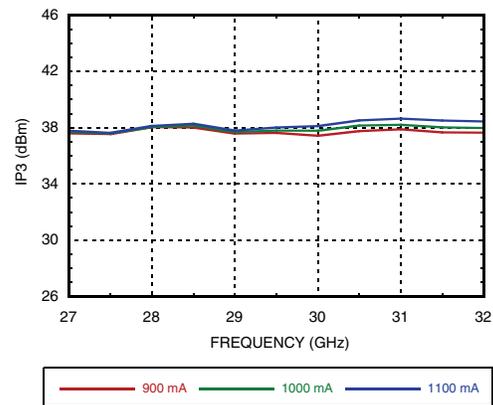
**Psat vs. Supply Current (Idd)**



**Output IP3 vs. Temperature, Pout/Tone = +28 dBm**



**Output IP3 vs. Supply Current, Pout/Tone = +28 dBm**



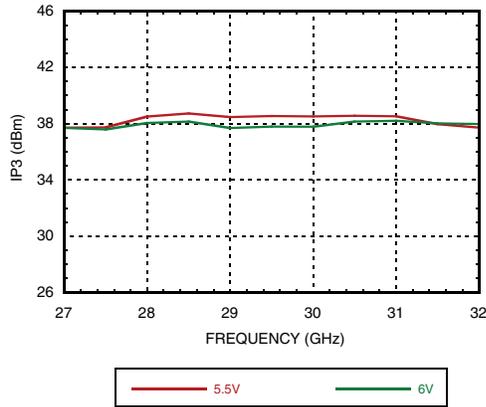
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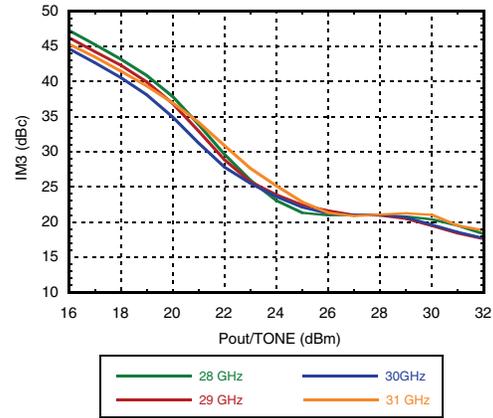


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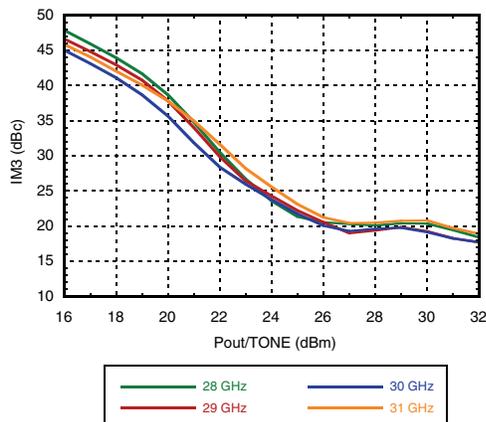
**Output IP3 vs. Supply Voltage, Pout/Tone = +28 dBm**



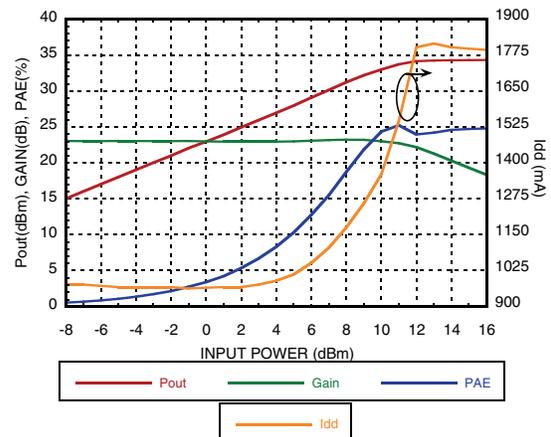
**Output IM3 @ Vdd = +5.5V**



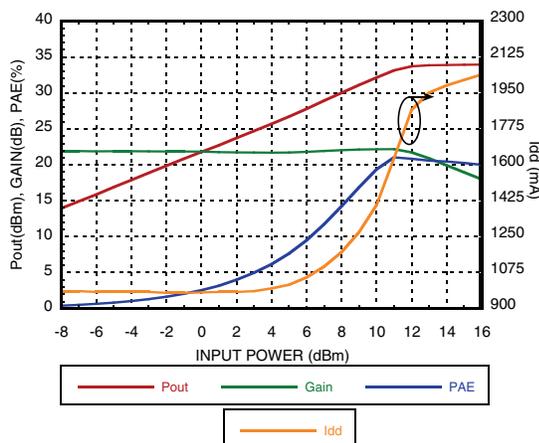
**Output IM3 @ Vdd = +6V**



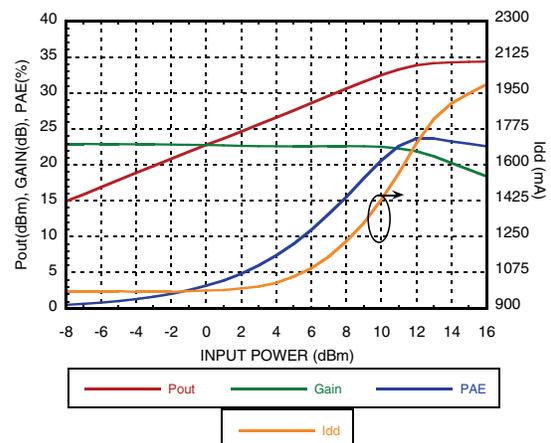
**Power Compression @ 27.5 GHz**



**Power Compression @ 29 GHz**



**Power Compression @ 31 GHz**



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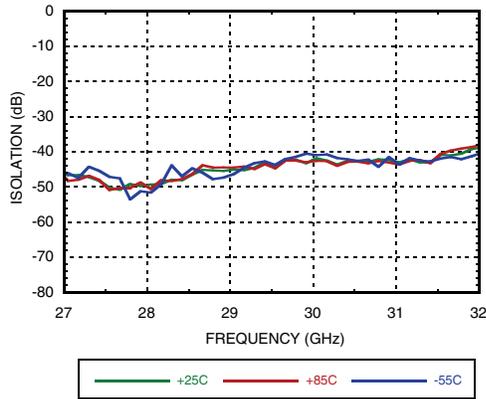
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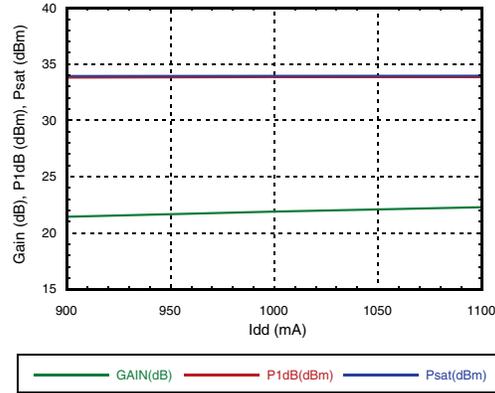
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AMPLIFIERS - LINEAR & POWER - CHIP

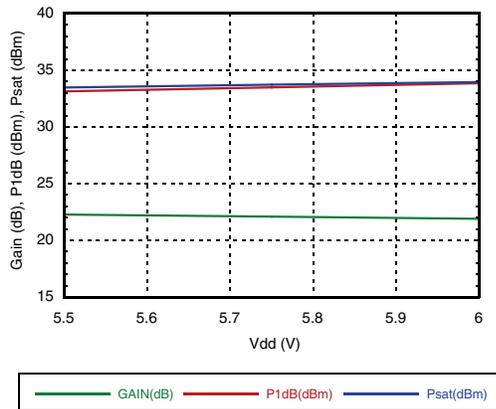
**Reverse Isolation vs. Temperature**



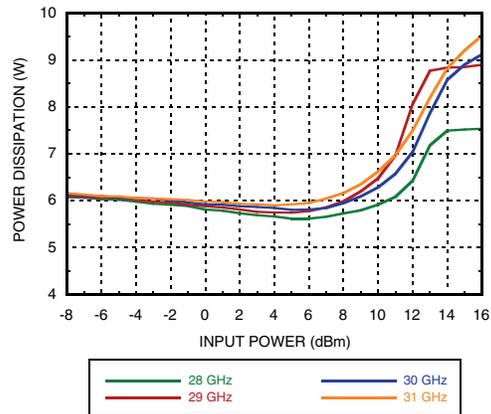
**Gain & Power vs. Supply Current @ 29 GHz**



**Gain & Power vs. Supply Voltage @ 29 GHz**



**Power Dissipation**



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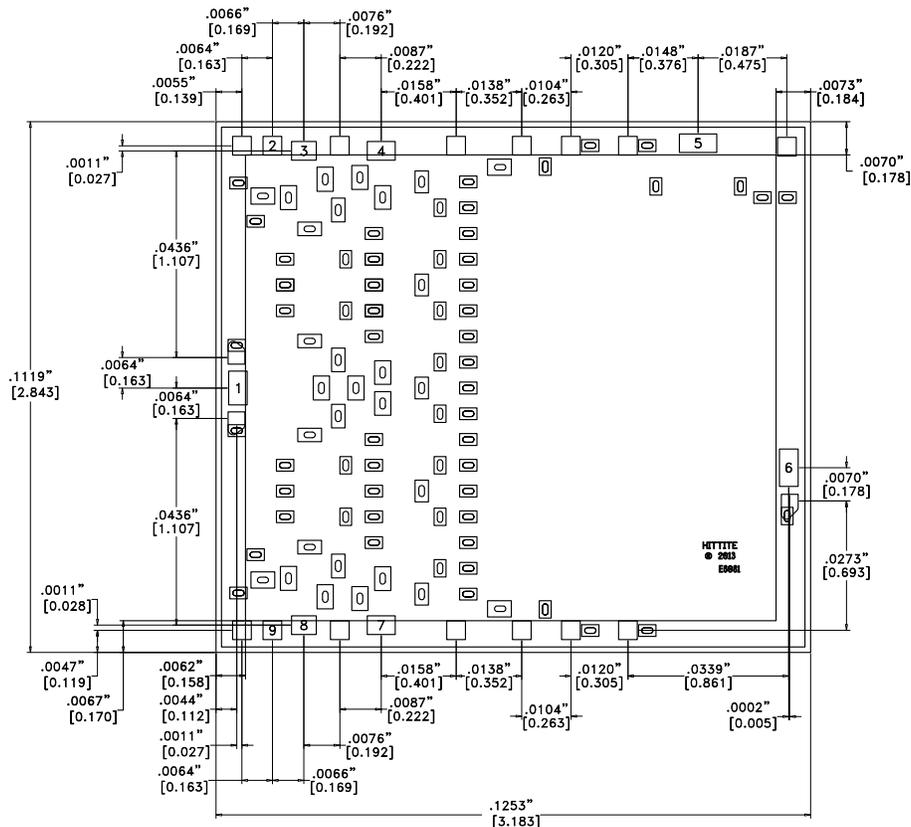
**Absolute Maximum Ratings**

Drain Bias Voltage (Vdd)	+6.5V
RF Input Power (RFIN)	+24 dBm
Channel Temperature	175 °C
Continuous Pdiss (T= 85 °C) (derate 125 mW/°C above 85°C)	10.5 W
Thermal Resistance (channel to die bottom)	8 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-55 to +85 °C
ESD Sensitivity (HBM)	Class 1A, Passed 250V



**ELECTROSTATIC SENSITIVE DEVICE  
OBSERVE HANDLING PRECAUTIONS**

**Outline Drawing**



**NOTES:**

1. ALL DIMENSIONS ARE IN INCHES [MM]
2. DIE THICKNESS IS .004"
3. TYPICAL BOND PAD IS 0.0026" [0.066] SQUARE
4. BACKSIDE METALLIZATION: GOLD
5. BOND PAD METALLIZATION: GOLD
6. BACKSIDE METAL IS GROUND.
7. CONNECTION NOT REQUIRED FOR UNLABELED BOND PADS.
8. OVERALL DIE SIZE ± .002

**Die Packaging Information [1]**

Standard	Alternate
GP-1 (Gel Pack)	[2]

[1] Refer to the "Packaging Information" section for die packaging dimensions.

[2] For alternate packaging information contact Hittite Microwave Corporation.

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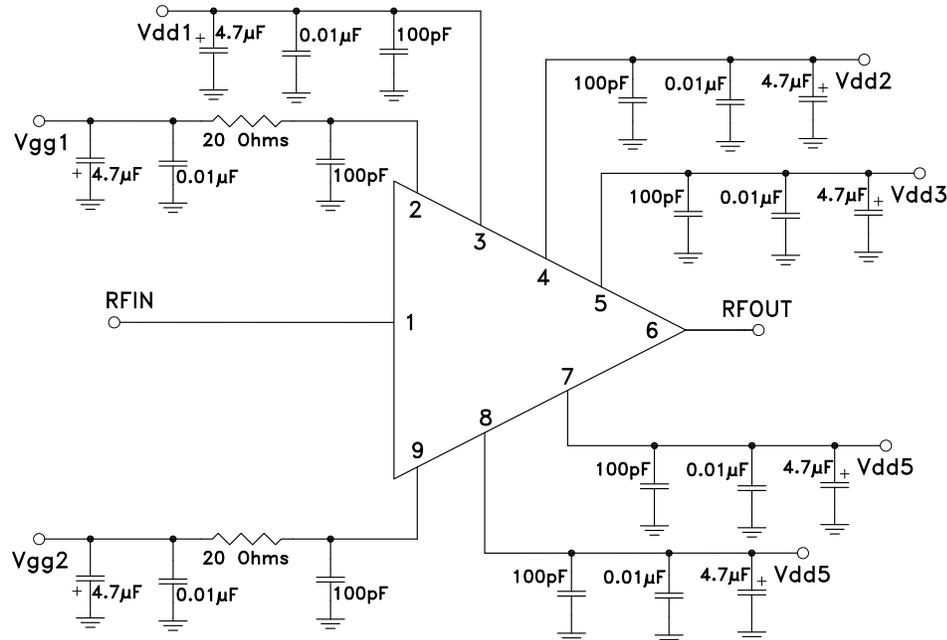


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**Pad Descriptions**

Pad Number	Function	Description	Interface Schematic
1	RFIN	RF signal input. This pin is AC coupled and matched to 50 Ohms over the operating frequency range.	RFIN
2, 9	Vgg1, Vgg2	Gate control for amplifier. Vgg1 and Vgg2. External bypass capacitors of 100pF, 0.01uF, and 4.7uF are required, also required is an in line 20 Ohm resistor, see Application Circuit.	Vgg1,2
3, 4, 5, 7, 8	Vdd1-4	Drain bias voltage for the top half of the amplifier. External bypass capacitors of 100pF required for each pin, followed by common 0.01uF and 4.7uF Capacitors.	Vdd1-5
7	RFOUT	RF signal output. This pad is AC coupled and matched to 50 Ohms over the operating frequency range.	RFOUT
Die Bottom	GND	Die bottom must be connected to RF/DC ground.	GND

**Application Circuit**



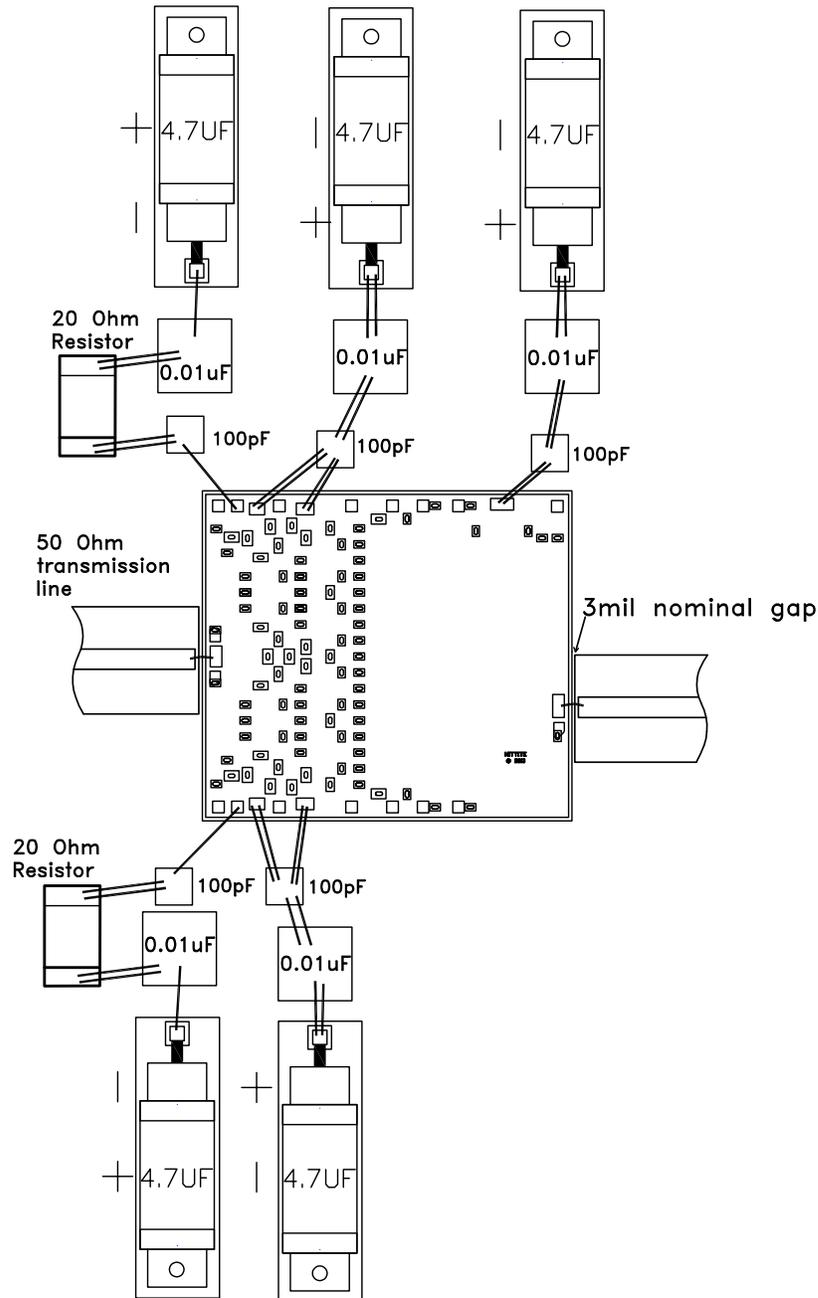
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**Assembly Diagram**



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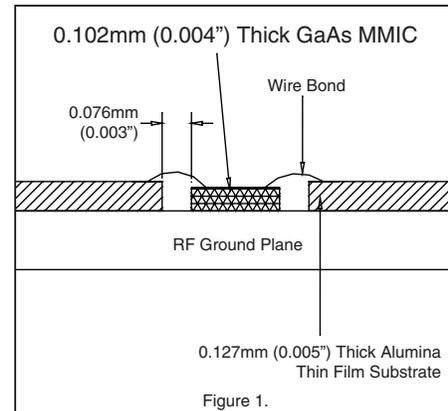
## GaAs pHEMT MMIC 2 WATT POWER AMPLIFIER, 27.5 - 31 GHz

### Mounting & Bonding Techniques for Millimeterwave GaAs MMICs

The die should be attached directly to the ground plane eutectically or with conductive epoxy (see HMC general Handling, Mounting, Bonding Note).

50 Ohm Microstrip transmission lines on 0.127mm (5 mil) thick alumina thin film substrates are recommended for bringing RF to and from the chip (Figure 1). If 0.254mm (10 mil) thick alumina thin film substrates must be used, the die should be raised 0.150mm (6 mils) so that the surface of the die is coplanar with the surface of the substrate. One way to accomplish this is to attach the 0.102mm (4 mil) thick die to a 0.150mm (6 mil) thick molybdenum heat spreader (moly-tab) which is then attached to the ground plane (Figure 2).

Microstrip substrates should be located as close to the die as possible in order to minimize bond wire length. Typical die-to-substrate spacing is 0.076mm to 0.152 mm (3 to 6 mils).



### Handling Precautions

Follow these precautions to avoid permanent damage.

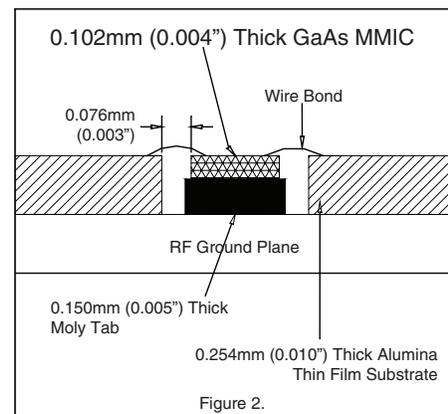
**Storage:** All bare die are placed in either Waffle or Gel based ESD protective containers, and then sealed in an ESD protective bag for shipment. Once the sealed ESD protective bag has been opened, all die should be stored in a dry nitrogen environment.

**Cleanliness:** Handle the chips in a clean environment. DO NOT attempt to clean the chip using liquid cleaning systems.

**Static Sensitivity:** Follow ESD precautions to protect against > ± 250V ESD strikes.

**Transients:** Suppress instrument and bias supply transients while bias is applied. Use shielded signal and bias cables to minimize inductive pick-up.

**General Handling:** Handle the chip along the edges with a vacuum collet or with a sharp pair of bent tweezers. The surface of the chip may have fragile air bridges and should not be touched with vacuum collet, tweezers, or fingers.



### Mounting

The chip is back-metallized and can be die mounted with AuSn eutectic preforms or with electrically conductive epoxy. The mounting surface should be clean and flat.

**Eutectic Die Attach:** A 80/20 gold tin preform is recommended with a work surface temperature of 255°C and a tool temperature of 265°C. When hot 90/10 nitrogen/hydrogen gas is applied, tool tip temperature should be 290°C. DO NOT expose the chip to a temperature greater than 320°C for more than 20 seconds. No more than 3 seconds of scrubbing should be required for attachment.

**Epoxy Die Attach:** Apply a minimum amount of epoxy to the mounting surface so that a thin epoxy fillet is observed around the perimeter of the chip once it is placed into position. Cure epoxy per the manufacturer's schedule.

### Wire Bonding

Ball or wedge bond with 0.025mm (1 mil) diameter pure gold wire. Thermosonic wirebonding with a nominal stage temperature of 150°C and a ball bonding force of 40 to 50 grams or wedge bonding force of 18 to 22 grams is recommended. Use the minimum level of ultrasonic energy to achieve reliable wirebonds. Wirebonds should be started on the chip and terminated on the package or substrate. All bonds should be as short as possible <0.31mm (12 mils).

**GaAs pHEMT MMIC 2 WATT  
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